List of Figures

1.1 The Lycurgus Cup. . . . 3
1.2 Surface Plasmons . . . 8
1.3 The Metal-Insulator-Metal Waveguide . . . 9
1.4 Metal-Insulator-Metal Generalized Schematic. . . . 10

2.1 32 Crystal System Symmetries . . . 14
2.2 ABO_3 Perovskite Unit Cell . . . 15
2.3 Landau Spontaneous Polarization . . . 18
2.4 Piezoresponse Force Microscopy . . . 19
2.5 Contact Angle Measurements . . . 21
2.6 The Layer Transfer Process . . . 22

3.1 Contact Angle Measurements . . . 26
3.2 Equilibrium concentration of available species in implanted $BaTiO_3$ as a function of temperature and pressure . . . 28
3.3 Equilibrium concentrations in the Ba-Ti-O-H system during cavity formation . . . 29
3.4 Cracking and blistering during layer transfer . . . 31
3.5 Forward recoil electron spectroscopy of implanted $BaTiO_3$ . . . 32
3.6 Raman spectroscopy of $BaTiO_3$ before, durning, and after layer transfer and post-bond annealing . . . 33
3.7 TEM of layer transfered $BaTiO_3$ . . . 34
3.8 AFM and PFM of bulk and layer transfered $BaTiO_3$ . . . 35
3.9 AFM and PFM of $BaTiO_3$ films using PLD and layer transfer . . . 36
3.10 Hysteresis curves of PLD and layer transfered $BaTiO_3$ . . . 37

4.1 Layer transfer geometry . . . 41

4.2 Geometry of a perturbed crack propagating in a film 43
4.3 Debonding with and without buckling 48
4.4 Energy release rate of an interfacial crack 49
4.5 Crack evolution diagrams thick and thin transfered layers 51
4.6 Transverse cracks during layer transfer under no applied stress 55
4.7 Telephone-cord-like cracks in compressively stressed $LiNbO_3$ 56
4.8 A buckled region of $LiNbO_3$ 57
4.9 Crack evolution diagram for the experimentally tested $LiNbO_3$ 59

5.1 TEM sample extraction in the FIB 65
5.2 TEM of Lithium Niobate Sample 66
5.3 Formation of the Silver Bond 67
5.4 Silver Grain Growth 68
5.5 Silver XRD before and after annealing 69

6.1 Lithium Niobate MIM Device Schematic 72
6.2 Lithium niobate membrane fabrication 73
6.3 Lithium niobate membranes before and after FIB 74
6.4 1964 CIE RGB Color Matching Functions 75
6.5 1964 CIE RGB Color Matching Functions 76
6.6 Silicon Nitride MIM Device Dispersion 76
6.7 Lithium Niobate Output Colors with Varying Slit Spacing 78
6.8 Power transmission through $LiNbO_3$ waveguides 79
6.9 Lithium Niobate MIM Dispersion Diagram 80
6.10 Mode Profiles within MIM Waveguides 81
6.11 Trapezoidal Slit Transmission with varying Dimensions 84
6.12 Trapezoid/Rectangle Hybrid Slit Transmission with varying Dimensions 85
6.13 Three-dimensional Implementation of MIM Color Filters 87

7.1 plasmostor Membrane Fabrication 91
7.2 XRD and Raman measurements of Silicon Membrane Strain 92
7.3 plasmostor Device Schematic 93
7.4 plasmostor Membrane Overview 94

7.5 plasMOStor Dispersion . . . 95
7.6 plasMOStor Dispersion . . . 96
7.7 plasMOStor FDTD Simulations at $\lambda = 1550$ nm . . . 97
7.8 plasMOStor FDTD Simulations at $\lambda = 685$ nm . . . 98
7.9 Capacitance-voltage and switching behavior of individual devices. . . . 99
7.10 plasMOStor Switching . . . 100
7.11 plasMOStor Circuit Analysis . . . 104

8.1 Plasma Frequency as a Function of Carrier Density . . . 107
8.2 MOS Structure Studied for $InTiO_3$ Ellipsometry . . . 108
8.3 Ellipsometry of $InTiO_3$ Under Applied Field . . . 109
8.4 Calculated Broadband Complex Index of $InTiO_3$ . . . 110
8.5 Accumulation Layer Complex Index in $InTiO_3$ . . . 111
8.6 Optical Modes in a $Au/InTiO_3/SiO_2/Au$ Waveguide . . . 112

9.1 Summary of Parameters Studied to Affect Color Filter Output Spectrum . . . 115
9.2 Summary of Parameters Studied to Affect plasMOStor Output Spectrum . . . 116

A.1 Coordinates for MIM Dispersion Calculations . . . 119

B.1 Three-Dimensional Piezoresponse Plot for Barium Titanate . . . 131

C.1 Schematic of Spectroscopic Ellipsometry . . . 133
C.2 Ellipsometry of $InTiO_3$ . . . 134